

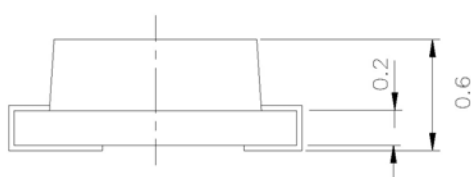
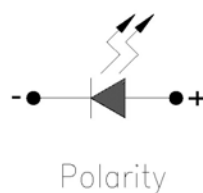
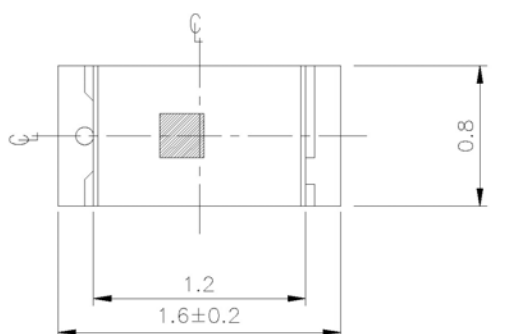
Features

- Fit automatic placement equipment.
- Fit Compatible with infrared and vapor phase reflow solder process.
- Pb-free.
- RoHS compliant.

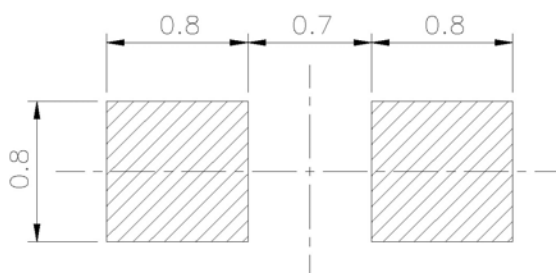
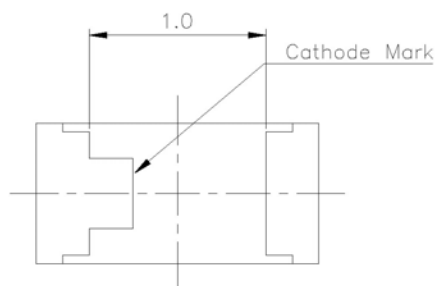
Descriptions

- For higher packing density .
- For minature applications .
- Water clear lens .
- Chip material : AlGaInP .
- Emitting color : Yellow Green .

Package Outline Dimensions



For reflow soldering (Propose)



Note: The tolerances unless mentioned is ± 0.1 mm , Unit = mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40~ +90	°C
Soldering Temperature	T _{sol}	260 (for 5 second)	°C
Electrostatic Discharge	ESD	2000	V
Power Dissipation	P _d	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	I _{F P}	60	mA

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	14.5	-----	57.0	mcd	I _F =20mA
Viewing Angle	2θ 1/2	-----	120	-----	deg	
Peak Wavelength	λ _p	-----	575	-----	nm	
Dominant Wavelength	λ _d	570.0	-----	574.5	nm	
Spectrum Radiation Bandwidth	△λ	-----	20	-----	nm	
Forward Voltage	V _F	1.75	-----	2.35	V	V _R =5V
Reverse Current	I _R	-----	-----	10	μA	

Bin Range Of Luminous

Bin	Min	Max	Unit	Condition
1	14.5	22.5	mcd	If=20mA
2	22.5	36.0		
3	36.0	57.0		

Bin Range Of Dom. Wavelength

Bin	Min	Max	Unit	Condition
1	570.0	571.5	nm	If=20mA
2	571.5	573.0		
3	573.0	574.5		

Bin Range Of Forward Voltage

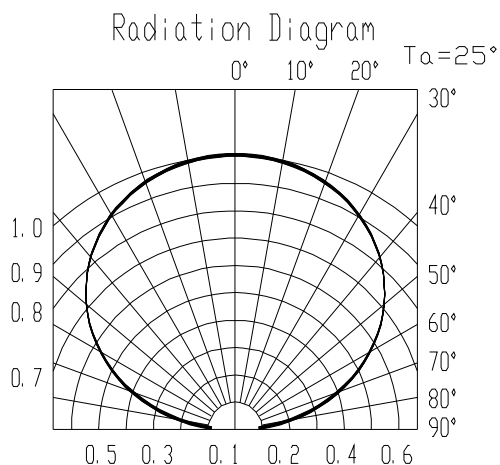
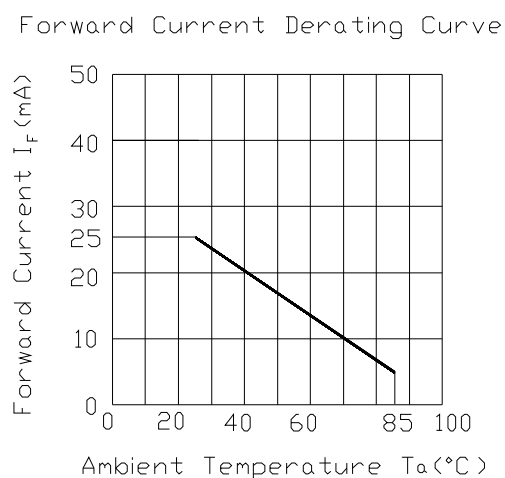
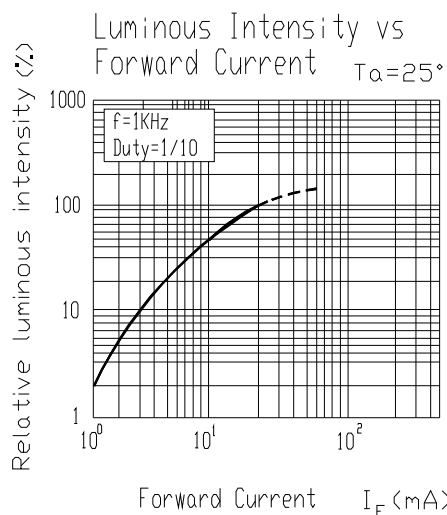
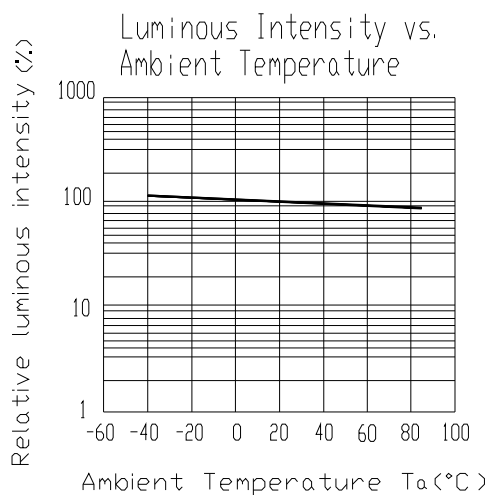
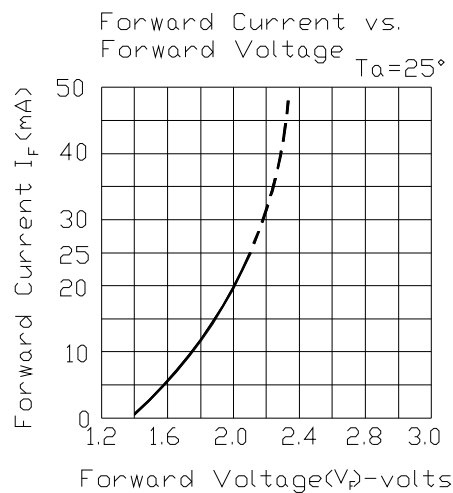
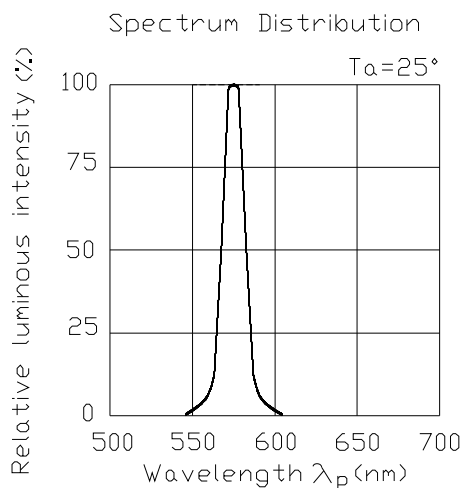
Bin	Min	Max	Unit	Condition
1	1.75	1.95	V	If=20mA
2	1.95	2.15		
3	2.15	2.35		

Specific binning requirements- please contact our home office

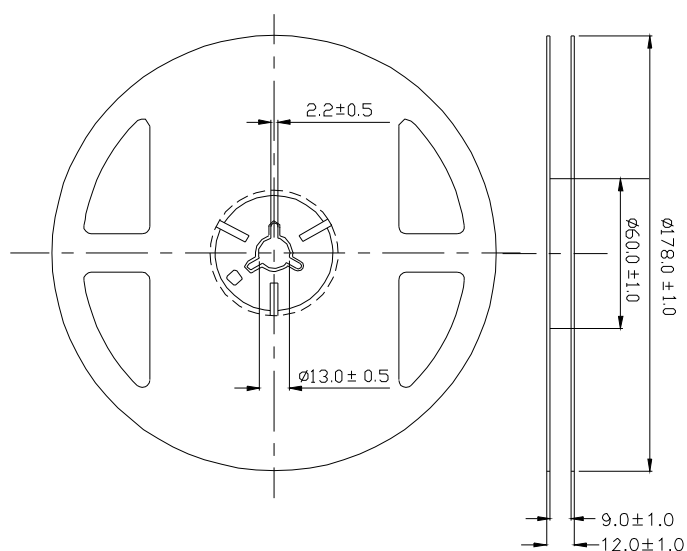
Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Dominant Wavelength $\pm 1\text{nm}$
- 3.Tolerance of Forward Voltage $\pm 0.1\text{V}$

Typical Electro-Optical Characteristics

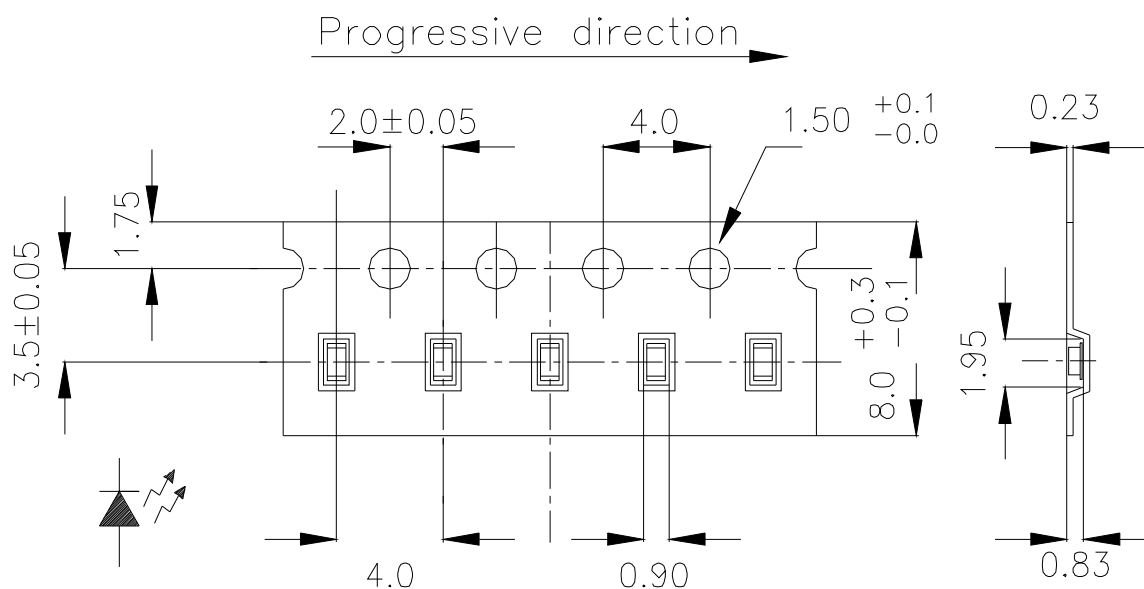


Reel Dimensions



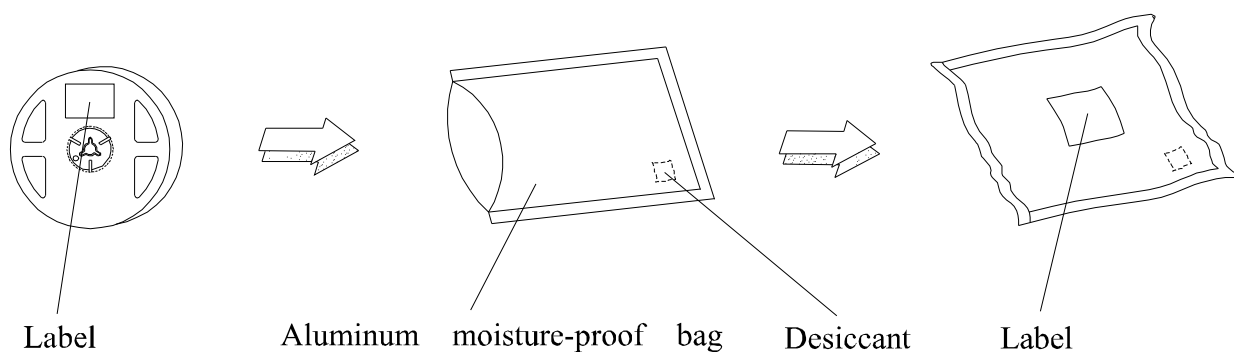
Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



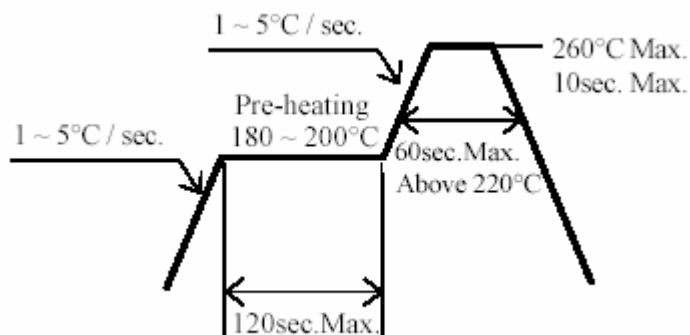
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Moisture Resistant Packaging



Soldering Condition

1. Pb-free solder temperature profile



2. Reflow soldering should not be done more than two times.

3 When soldering, do not put stress on the LEDs during heating.

4 After soldering, do not warp the circuit board.

Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

AMEYA360

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